

# **TCS3771**

# **Color Light-To-Digital Converter with Proximity Sensing**

## **General Description**

The TCS3771 family of devices provides red, green, blue, and clear (RGBC) light sensing and proximity detection (when coupled with an external IR LED). They detect light intensity under a variety of lighting conditions and through a variety of attenuation materials. The proximity detection feature allows a large dynamic range of operation for use in short distance detection behind dark glass such as in a cell phone or for longer distance measurements for applications such as presence detection for monitors or laptops. The programmable proximity detection enables continuous measurements across the entire range. In addition, an internal state machine provides the ability to put the device into a low power mode in between RGBC and proximity measurements providing very low average power consumption.

The TCS3771 is directly useful in lighting conditions containing minimal IR content such as LED RGB backlight control, reflected LED color sampler, or fluorescent light color temperature detector. With the addition of an IR blocking filter, the device is an excellent ambient light sensor, color temperature monitor, and general purpose color sensor.

The proximity function is targeted specifically towards battery-powered mobile devices, LCD monitor, laptop, and flat-panel television applications. In cell phones, the proximity detection can detect when the user positions the phone close to their ear. The device is fast enough to provide proximity information at a high repetition rate needed when answering a phone call. It can also detect both close and far distances so the application can implement more complex algorithms to provide a more robust interface. In laptop or monitor applications, the product is sensitive enough to determine whether a user is in front of the laptop using the keyboard or away from the desk. This provides both improved green power saving capability and the added security to lock the computer when the user is not present.

Ordering Information and Content Guide appear at end of datasheet.

Page 1



# **Key Benefits & Features**

The benefits and features of the TCS3771 are listed below:

Figure 1: Added Value of using TCS3771

Benefits	Features
Single Device reduces board space	RGB Color Sensing and Proximity Detection in a Single Device
Enables both Correlated Color     Temperature and Ambient Light     Sensing across wide range of lighting     condition applications	<ul> <li>Color Light Sensing</li> <li>Programmable Analog Gain, Integration Time, and Interrupt Function with Upper and Lower Thresholds</li> <li>Resolution Up to 16 bits</li> <li>Very High Sensitivity - Ideally Suited for Operation Behind Dark Glass</li> <li>Up to 1,000,000:1 Dynamic Range</li> </ul>
Enables versatile Infra-red proximity based object detection	<ul> <li>Proximity Detection</li> <li>Programmable Number of IR Pulses, Current Sink for the IR LED - No Limiting Resistor Needed, and Interrupt Function with Upper and Lower Thresholds</li> <li>Covers a 2000:1 Dynamic Range</li> </ul>
Low power wait state programmability reduces average power consumption	<ul> <li>Low Power Wait State</li> <li>65µA Typical Current</li> <li>Wait Timer is Programmable from 2.4ms to &gt; 7 seconds</li> </ul>
Digital interfaces are less susceptible to noise	<ul> <li>I<sup>2</sup>C Interface Compatible</li> <li>Up to 400kHz (I<sup>2</sup>C Fast Mode)</li> </ul>
Reduces micro-processor Interrupt     Overhead with both up persist and     no-persist interrupt thresholds	Dedicated Interrupt Pin
Enables drop-in and foot-print compatible solutions	Pin and Register Set Compatible with the TCS3x7x Family of Devices
Reduces board space requirements while simplifying designs	Small 2mm × 2.4mm Dual Flat No-Lead Package
Low power sleep state reduces average power consumption	• Sleep Mode - 2.5µA Typical Current

# **Applications**

The applications of TCS3771 include:

- RGB LED Backlight Control
- Ambient Color Temperature Sensing
- Cell Phone Touch Screen Disable
- Notebook/Monitor Security
- Automatic Menu Popup

Page 2ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



- Industrial Process Control
- Medical Diagnostics

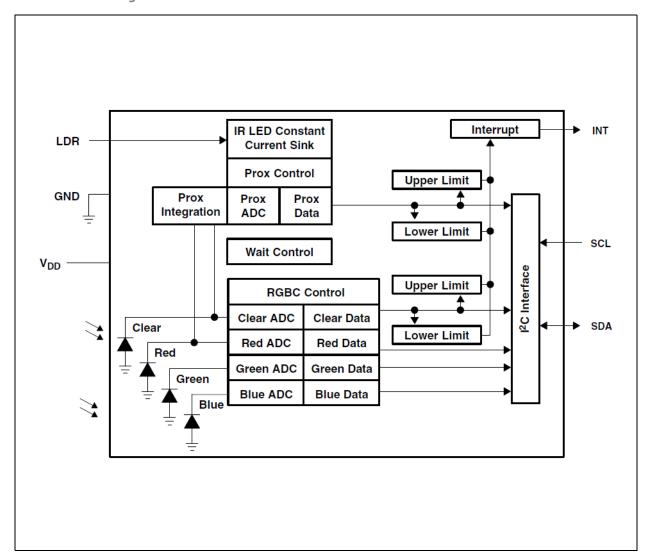
## **End Products and Market Segments**

- HDTVs, Mobile Handsets, Tablets, Laptops, Monitors, PMP (Portable Media Payers)
- Medical and Commercial Instrumentation
- Consumer Toys
- Industrial/Commercial Lighting

## **Block Diagram**

The functional blocks of this device for reference are shown below:

Figure 2: TCS3771 Block Diagram



ams Datasheet Page 3
[v1-31] 2018-Apr-04 Document Feedback



## **Detailed Description**

The TCS3771 light-to-digital device contains a  $4 \times 4$  photodiode array, integrating amplifiers, ADCs, accumulators, clocks, buffers, comparators, a state machine, and an  $I^2C$  interface. The  $4 \times 4$  photodiode array is composed of red-filtered, green-filtered, blue-filtered, and clear photodiodes - four of each type. Four integrating ADCs simultaneously convert the amplified photodiode currents to a digital value providing up to 16 bits of resolution. Upon completion of the conversion cycle, the conversion result is transferred to the data registers. The transfers are double-buffered to ensure that the integrity of the data is maintained. Communication to the device is accomplished through a fast (up to  $400 \, \text{kHz}$ ), two-wire  $I^2C$  serial bus for easy connection to a microcontroller or embedded controller.

The TCS3771 provides a separate pin for level-style interrupts. When interrupts are enabled and a preset value is exceeded, the interrupt pin is asserted and remains asserted until cleared by the controlling firmware. The interrupt feature simplifies and improves system efficiency by eliminating the need to poll a sensor for a light intensity or proximity value. An interrupt is generated when the value of an RGBC or proximity conversion exceeds either an upper or lower threshold. In addition, a programmable interrupt persistence feature allows the user to determine how many consecutive exceeded thresholds are necessary to trigger an interrupt. Interrupt thresholds and persistence settings are configured independently for both RGBC and proximity.

Proximity detection requires only a single external IR LED. An internal LED driver can be configured to provide a constant current sink of 12.5mA, 25mA, 50mA or 100mA of current. No external current limiting resistor is required. The number of proximity LED pulses can be programmed from 1 to 255 pulses. Each pulse has a 14µs period. This LED current coupled with the programmable number of pulses provides a 2000:1 contiguous dynamic range.

Page 4
Document Feedback
[v1-31] 2018-Apr-04



# **Pin Assignments**

The TCS3771 pin assignments are described below:

Figure 3:
Pin Diagram of Package FN Dual Flat No-Lead (Top View)

Package drawing not to scale.

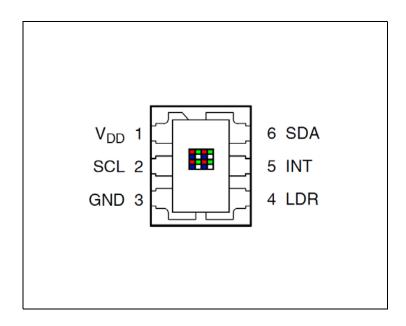


Figure 4: Terminal Functions

Terr	Terminal		Description
Name	No	Type	Description
V <sub>DD</sub>	1		Supply voltage
SCL	2	I	I <sup>2</sup> C serial clock input terminal - clock signal for I <sup>2</sup> C serial data
GND	3		Power supply ground. All voltages are referenced to GND.
LDR	4	0	LED driver for proximity emitter - up to 100mA, open drain
INT	5	0	Interrupt - open drain (active low)
SDA	6	I/O	I <sup>2</sup> C serial data I/O terminal - serial data I/O for I <sup>2</sup> C

ams Datasheet Page 5
[v1-31] 2018-Apr-04 Document Feedback



# **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 5:
Absolute Maximum Ratings over Operating Free-Air Temperature Range (unless otherwise noted)

Symbol	Parameter	Min	Max	Unit
V <sub>DD</sub>	Supply voltage <sup>(1)</sup>		3.8	V
V <sub>O</sub>	Digital output voltage range	-0.5	3.8	V
Io	Digital output current	-1	20	mA
T <sub>stg</sub>	Storage temperature range	-40	85	°C
	ESD tolerance, human body model		2000	V

#### Note(s):

1. All voltages are with respect to GND.

Page 6ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



## **Electrical Characteristics**

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

Figure 6: **Recommended Operating Conditions** 

Symbol	Parameter	Min	Nom	Max	Unit
V <sub>DD</sub>	Supply voltage	2.7	3	3.3	V
T <sub>A</sub>	Operating free-air temperature	-30		70	°C

Figure 7: Operating Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25$ °C (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
		Active - LDR pulses off		235	330	
I <sub>DD</sub>	Supply current	Wait mode		65		μΑ
		Sleep mode - no I <sup>2</sup> C activity		2.5	10	
V <sub>OL</sub>	INT, SDA output low	3mA sink current	0		0.4	V
VOL.	voltage	6mA sink current	0		0.6	v
I <sub>LEAK</sub>	Leakage current, SDA, SCL, INT pins		-5		5	μΑ
I <sub>LEAK</sub>	Leakage current, LDR pin		-10		+10	μΑ
V <sub>IH</sub>	SCL, SDA input high	TCS37715	0.7 V <sub>DD</sub>			V
YIH	voltage	TCS37717	1.25			v
V <sub>IL</sub>	SCL, SDA input low	TCS37715			0.3V <sub>DD</sub>	V
	voltage	TCS37717			0.54	-

ams Datasheet Page 7 Document Feedback



Figure 8: Optical Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25$ °C, Gain = 16, ATIME = 0xF6 (unless otherwise noted) (1)

	Parameter	Test	Re	d Chan	inel	Gre	en Cha	nnel	Blu	ue Char	nel
		Conditions	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max
		$\lambda_{\rm D} = 465  {\rm nm},  ^{(2)}$	0%		15%	10%		42%	65%		88%
R <sub>e</sub>	Irradiance responsivity	$\lambda_{D} = 525$ nm, <sup>(3)</sup>	6%		25%	60%		85%	9%		35%
		$\lambda_{D} = 625 \text{nm}, ^{(4)}$	85%		110%	0%		15%	5%		25%

#### Note(s):

- 1. The percentage shown represents the ratio of the respective red, green, or blue channel value to the clear channel value.
- 2. The 465nm input irradiance is supplied by an InGaN light-emitting diode with the following characteristics: dominant wavelength  $\lambda_D$  = 465nm, spectral halfwidth  $\Delta\lambda 1/2$  = 22nm, and luminous efficacy = 75lm/W.
- 3. The 525nm input irradiance is supplied by an InGaN light-emitting diode with the following characteristics: dominant wavelength  $\lambda_D$  = 525nm, spectral halfwidth  $\Delta\lambda 1/2$  = 35nm, and luminous efficacy = 520lm/W.
- 4. The 625nm input irradiance is supplied by a AllnGaP light-emitting diode with the following characteristics: dominant wavelength  $\lambda_D$  = 625nm, spectral halfwidth  $\Delta\lambda 1/2$  = 9nm, and luminous efficacy = 155lm/W.



Figure 9: RGBC Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25$ °C, AGAIN = 16, AEN = 1 (unless otherwise noted)

Parameter	Test Conditions	Min	Тур	Max	Unit
Dark ADC count value	$E_e = 0$ , AGAIN = 60×, ATIME = 0xD6 (100ms)	0	1	5	Counts
ADC integration time step size	ATIME = 0xFF	2.27	2.4	2.56	ms
ADC number of integration steps		1		256	Steps
ADC counts per step		0		1024	Counts
ADC count value	ATIME = 0xC0 (153.6ms)	0		65535	Counts
	4x	3.8	4	4.2	
Gain scaling, relative to 1× gain setting	16×	15	16	16.8	%
	60×	58	60	63	

ams Datasheet Page 9
[v1-31] 2018-Apr-04 Document Feedback



Figure 10: Proximity Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25$ °C, Gain = 16, PEN = 1 (unless otherwise noted)

	Parameter	Test Conditions	Condition	Min	Тур	Max	Unit
I <sub>DD</sub>	Supply current	LDR pulse on		3		mA	
	ADC conversion time step size	PTIME = 0xFF		2.27	2.4	2.56	ms
	ADC number of integration steps			1		256	Steps
	ADC counts per step			0		1023	Counts
	IR LED pulse count			0		255	Pulses
	LED pulse period	Two or more pulses			14		μs
	LED pulse width - LED on time				6.3		μs
			PDRIVE = 0	80	106	132	
	LED drive current	I <sub>SINK</sub> sink current @	PDRIVE = 1		50		mA
	LED anve carrent	600mV, LDR pin	PDRIVE = 2		25		
			PDRIVE = 3		12.5		
	Dark count value	$E_e = 0$ , PTIME = 0xFB, PPU	LSE = 2			900	Counts
	Red channel	$\lambda_P = 850$ nm, $E_e = 45.3 \mu W$ , PTIME = 0xFB, PPULSE = 2	1000		3000	Counts	
	Clear channel	$\lambda_P = 850$ nm, $E_e = 45.3 \mu W_e$ PTIME = 0xFB, PPULSE = 2	1000		3000	Counts	
	Operating distance (2)				30		Inches

#### Note(s):

- 1. The specified light intensity is 100% modulated by the pulse output of the device so that during the pulse output low time, the light intensity is at the specified level, and 0 otherwise.
- 2. Proximity Operating Distance is dependent upon emitter properties and the reflective properties of the proximity surface. The nominal value shown uses an IR emitter with a peak wavelength of 850nm and a 20° half angle. The proximity surface used is a 90% reflective (white surface) 16 × 20-inch Kodak Gray Card. 60mw/SR, 100mA, 64 pulses, open view (no glass). **Greater distances are achievable with appropriate system considerations.**

Figure 11: Wait Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25$ °C, Gain = 16, WEN = 1 (unless otherwise noted)

Parameter	Test Conditions	Channel	Min	Тур	Max	Unit
Wait step size	WTIME = 0xFF	WTIME = 0xFF				ms
Wait number of steps			1		256	Steps

Page 10ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



Figure 12: AC Electrical Characteristics,  $V_{DD} = 3V$ ,  $T_A = 25^{\circ}C$  (unless otherwise noted)

Symbol	Parameter <sup>(1)</sup>	Test Conditions	Min	Тур	Max	Unit
f <sub>(SCL)</sub>	Clock frequency (I <sup>2</sup> C only)		0		400	kHz
t <sub>(BUF)</sub>	Bus free time between start and stop condition		1.3			μs
t <sub>(HDSTA)</sub>	Hold time after (repeated) start condition. After this period, the first clock is generated.		0.6			μs
t <sub>(SUSTA)</sub>	Repeated start condition setup time		0.6			μs
t <sub>(SUSTO)</sub>	Stop condition setup time		0.6			μs
t <sub>(HDDAT)</sub>	Data hold time		0			μs
t <sub>(SUDAT)</sub>	Data setup time		100			ns
t <sub>(LOW)</sub>	SCL clock low period		1.3			μs
t <sub>(HIGH)</sub>	SCL clock high period		0.6			μs
t <sub>F</sub>	Clock/data fall time				300	ns
t <sub>R</sub>	Clock/data rise time				300	ns
C <sub>i</sub>	Input pin capacitance				10	pF

#### Note(s):

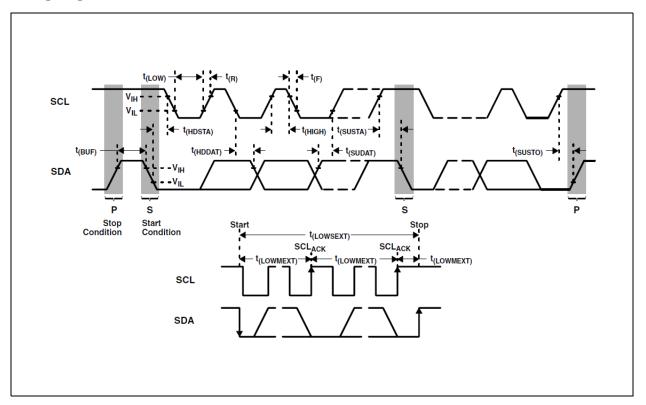
1. Specified by design and characterization; not production tested.

ams Datasheet Page 11
[v1-31] 2018-Apr-04 Document Feedback



# Parameter Measurement Information

Figure 13: Timing Diagrams



Page 12ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



# **Typical Characteristics**

Figure 14: Photodiode Spectral Responsivity

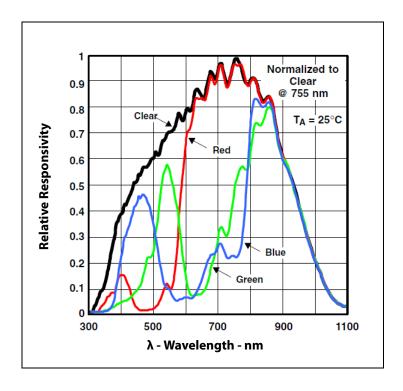
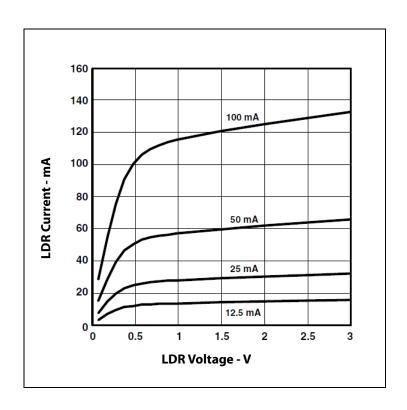


Figure 15: Typical LDR Current vs. Voltage



ams Datasheet Page 13
[v1-31] 2018-Apr-04 Document Feedback



Figure 16: Normalized  $I_{DD}$  vs.  $V_{DD}$  and Temperature

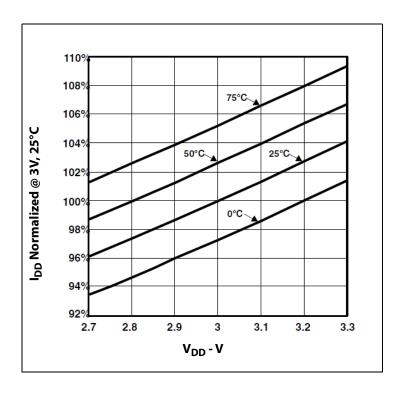
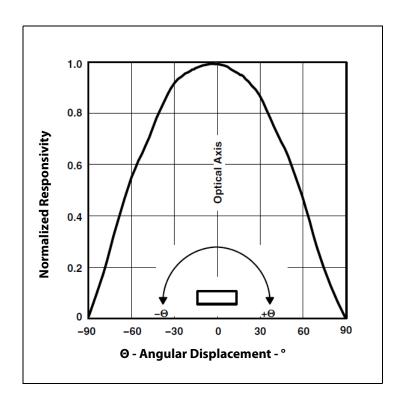


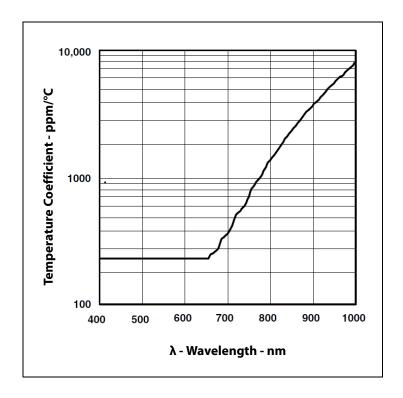
Figure 17:
Normalized Responsivity vs. Angular Displacement



Page 14ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



Figure 18: Responsivity Temperature Coefficient



ams Datasheet Page 15
[v1-31] 2018-Apr-04 Document Feedback

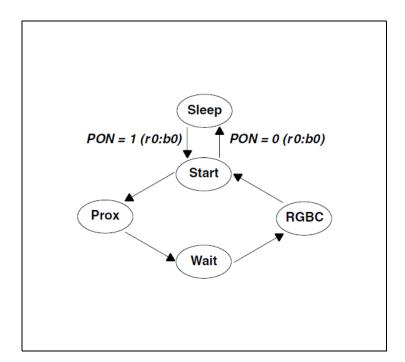


## **Principles of Operation**

#### **System State Machine**

The TCS3771 provides control of RGBC, proximity detection, and power management functionality through an internal state machine (Figure 19). After a power-on-reset, the device is in the sleep mode. As soon as the PON bit is set, the device will move to the start state. It will then continue through the Prox, Wait, and RGBC states. If these states are enabled, the device will execute each function. If the PON bit is set to 0, the state machine will continue until all conversions are completed and then go into a low power sleep mode.

Figure 19: Simplified State Diagram



**Note(s):** In this document, the nomenclature uses the bit field name in italics followed by the register number and bit number to allow the user to easily identify the register and bit that controls the function. For example, the power on (PON) is in register 0, bit 0. This is represented as *PON (r0:b0)*.

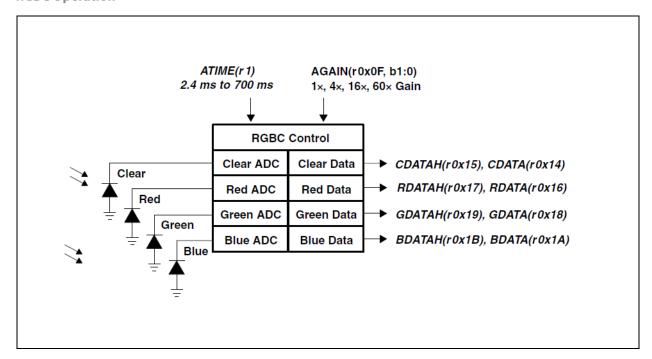
Page 16
Document Feedback
[v1-31] 2018-Apr-04



#### **RGBC Operation**

The RGBC engine contains RGBC gain control (AGAIN) and four integrating analog-to-digital converters (ADC) for the RGBC photodiodes. The RGBC integration time (ATIME) impacts both the resolution and the sensitivity of the RGBC reading. Integration of all four channels occurs simultaneously and upon completion of the conversion cycle, the results are transferred to the color data registers. This data is also referred to as channel count. The transfers are double-buffered to ensure that invalid data is not read during the transfer. After the transfer, the device automatically moves to the next state in accordance with the configured state machine.

Figure 20: RGBC Operation



The registers for programming the integration and wait times are a 2's compliment values. The actual time can be calculated as follows:

ATIME = 256 - Integration Time / 2.4ms

Inversely, the time can be calculated from the register value as follows:

Integration Time = 2.4ms  $\times$  (256 - ATIME)

For example, if a 100-ms integration time is needed, the device needs to be programmed to:

$$256 - (100 / 2.4) = 256 - 42 = 214 = 0 \times D6$$

Conversely, the programmed value of 0xC0 would correspond to:

$$(256 - 0xC0) \times 2.4 = 64 \times 2.4 = 154$$
ms

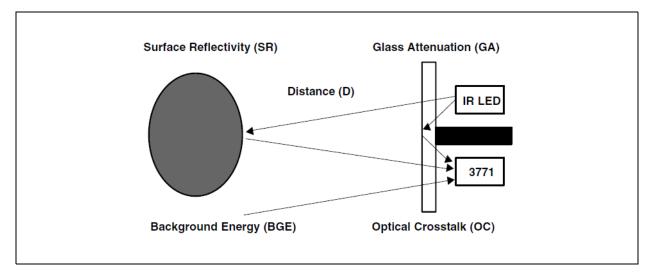
ams Datasheet Page 17
[v1-31] 2018-Apr-04 Document Feedback



### **Proximity Detection**

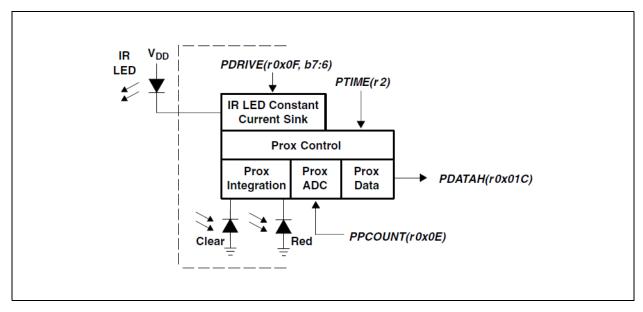
Proximity sensing uses an external light source (generally an infrared emitter) to emit light, which is then viewed by the integrated light detector to measure the amount of reflected light when an object is in the light path (Figure 21). The amount of light detected from a reflected surface can then be used to determine an object's proximity to the sensor.

Figure 21: Proximity Detection



The TCS3771 has controls for the number of IR pulses (PPCOUNT), the integration time (PTIME), the LED drive current (PDRIVE) and the photodiode configuration (PDIODE). The photodiode configuration can be set to red diode (recommended), clear diode, or a combination of both diodes. At the end of the integration cycle, the results are latched into the proximity data (PDATA) register.

Figure 22: Proximity Detection Operation



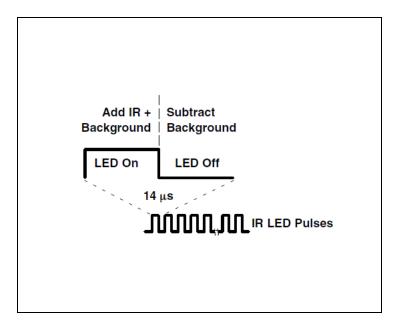
Page 18
Document Feedback
[v1-31] 2018-Apr-04



The LED drive current is controlled by a regulated current sink on the LDR pin. This feature eliminates the need to use a current limiting resistor to control LED current. The LED drive current can be configured for 12.5mA, 25mA, 50mA, or 100mA. For higher LED drive requirements, an external P-FET transistor can be used to control the LED current.

The number of LED pulses can be programmed to any value between 1 and 255 pulses as needed. Increasing the number of LED pulses at a given current will increase the sensor sensitivity. Sensitivity grows by the square root of the number of pulses. Each pulse has a 14µs period.

Figure 23: **Proximity IR LED Waveform** 



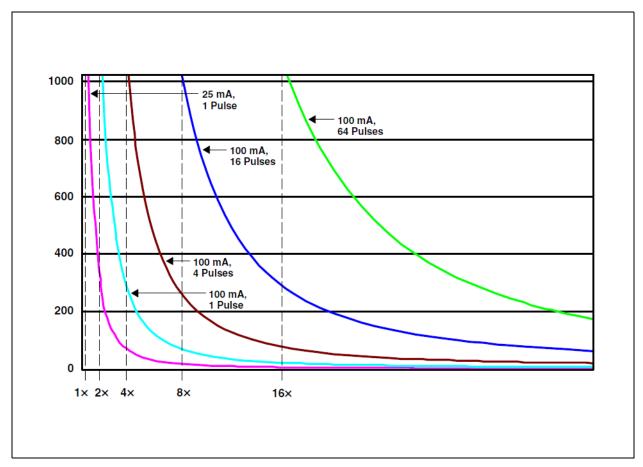
The proximity integration time (PTIME) is the period of time that the internal ADC converts the analog signal to a digital count. It is recommend that this be set to a minimum of PTIME = 0xFF or 2.4ms.

ams Datasheet Page 19 Document Feedback



The combination of LED power and number of pulses can be used to control the distance at which the sensor can detect proximity. Figure 24 shows an example of the distances covered with settings such that each curve covers 2× the distance. Counts up to 64 pulses provide a 16× range.

Figure 24: Proximity ADC Count vs. Relative Distance



### Interrupts

The interrupt feature simplifies and improves system efficiency by eliminating the need to poll the sensor for light intensity or proximity values outside of a user-defined range. While the interrupt function is always enabled and it's status is available in the status register (0x13), the output of the interrupt state can be enabled using the proximity interrupt enable (PIEN) or RGBC interrupt enable (AIEN) fields in the Enable Register (0x00).

Four 16-bit interrupt threshold registers allow the user to set limits below and above a desired light level and proximity range. An interrupt can be generated when the RGBC Clear data (CDATA) falls outside of the desired light level range, as determined by the values in the RGBC interrupt low threshold registers (AILTx) and RGBC interrupt high threshold registers (AIHTx). Likewise, an out-of-range proximity interrupt can be generated when the proximity data (PDATA) falls below the

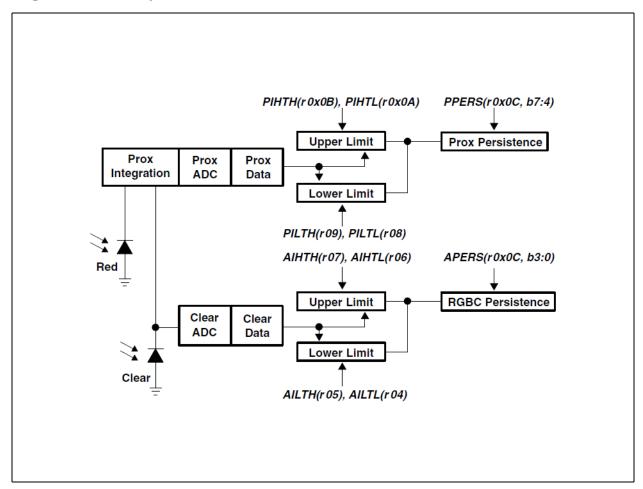
Page 20
Document Feedback
[v1-31] 2018-Apr-04



proximity interrupt low threshold (PILTx) or exceeds the proximity interrupt high threshold (PIHTx). It is important to note that the low threshold value must be less than the high threshold value for proper operation.

To further control when an interrupt occurs, the device provides a persistence filter. The persistence filter allows the user to specify the number of consecutive out-of-range RGBC or proximity occurrences before an interrupt is generated. The persistence register (0x0C) allows the user to set the RGBC persistence (APERS) and the proximity persistence (PPERS) values. See the persistence register for details on the persistence filter values. Once the persistence filter generates an interrupt, it will continue until a special function interrupt clear command is received (see Command Register).

Figure 25: Programmable Interrupt



ams Datasheet Page 21
[v1-31] 2018-Apr-04 Document Feedback



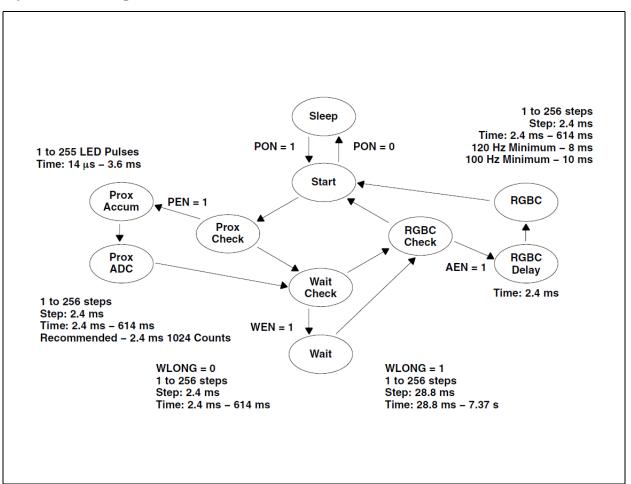
#### **State Diagram**

Figure 26 shows a more detailed flow for the state machine. The device starts in the sleep mode. The PON bit is written to enable the device. A 2.4ms delay will occur before entering the start state. If the PEN bit is set, the state machine will step through the proximity states of proximity accumulate and then proximity ADC conversion. As soon as the conversion is complete, the state machine will move to the following state.

If the WEN bit is set, the state machine will then cycle through the wait state. If the WLONG bit is set, the wait cycles are extended by 12× over normal operation. When the wait counter terminates, the state machine will step to the RGBC state.

The AEN should always be set, even in proximity-only operation. In this case, a minimum of 1 integration time step should be programmed. The RGBC state machine will continue until it reaches the terminal count at which point the data will be latched in the RGBC register and the interrupt set, if enabled.

Figure 26: Expanded State Diagram



Page 22

Document Feedback

[v1-31] 2018-Apr-04



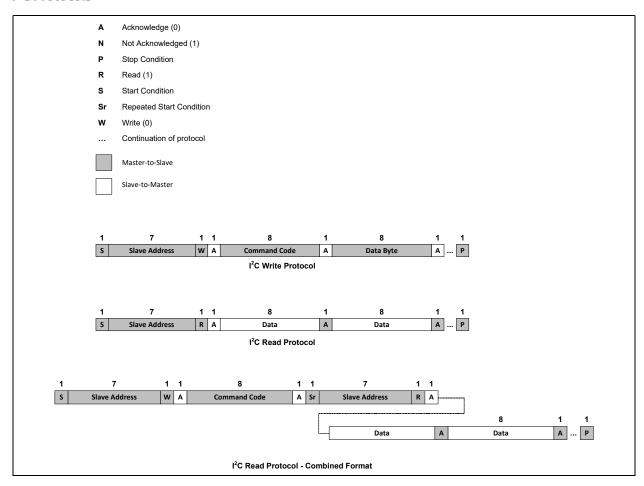
### I<sup>2</sup>C Protocol

Interface and control are accomplished through an I<sup>2</sup>C serial compatible interface (standard or fast mode) to a set of registers that provide access to device control functions and output data. The devices support the 7-bit I<sup>2</sup>C addressing protocol.

The I<sup>2</sup>C standard provides for three types of bus transaction: read, write, and a combined protocol (Figure 27). During a write operation, the first byte written is a command byte followed by data. In a combined protocol, the first byte written is the command byte followed by reading a series of bytes. If a read command is issued, the register address from the previous command will be used for data access. Likewise, if the MSB of the command is not set, the device will write a series of bytes at the address stored in the last valid command with a register address. The command byte contains either control information or a 5-bit register address. The control commands can also be used to clear interrupts.

The I<sup>2</sup>C bus protocol was developed by Philips (now NXP). For a complete description of the I<sup>2</sup>C protocol, please review the NXP I<sup>2</sup>C design specification at http://www.i2c-bus.org/references.

Figure 27: I<sup>2</sup>C Protocols



ams Datasheet Page 23
[v1-31] 2018-Apr-04 Document Feedback



# **Register Set**

The TCS3771 is controlled and monitored by data registers and a command register accessed through the serial interface. These registers provide for a variety of control functions and can be read to determine results of the ADC conversions. The Register Set is summarized in Figure 28.

Figure 28: Register Address

Address	Register Name	R/W	Register Function	Reset Value
	COMMAND	W	Specifies register address	0x00
0x00	ENABLE	R/W	Enables states and interrupts	0x00
0x01	ATIME	R/W	RGBC ADC time	0xFF
0x02	PTIME	R/W	Proximity ADC time	0xFF
0x03	WTIME	R/W	Wait time	0xFF
0x04	AILTL	R/W	RGBC interrupt low threshold low byte	0x00
0x05	AILTH	R/W	RGBC interrupt low threshold high byte	0x00
0x06	AIHTL	R/W	RGBC interrupt high threshold low byte	0x00
0x07	AIHTH	R/W	RGBC interrupt high threshold high byte	0x00
0x08	PILTL	R/W	Proximity interrupt low threshold low byte	0x00
0x09	PILTH	R/W	Proximity interrupt low threshold high byte	0x00
0x0A	PIHTL	R/W	Proximity interrupt high threshold low byte	0x00
0x0B	PIHTH	R/W	Proximity interrupt high threshold high byte	0x00
0x0C	PERS	R/W	Interrupt persistence filters	0x00
0x0D	CONFIG	R/W	Configuration	0x00
0x0E	PPCOUNT	R/W	Proximity pulse count	0x00
0x0F	CONTROL	R/W	Gain control register	0x00
0x12	ID	R	Device ID	ID
0x13	STATUS	R	Device status	0x00
0x14	CDATA	R	Clear ADC low data register	0x00
0x15	CDATAH	R	Clear ADC high data register	0x00
0x16	RDATA	R	Red ADC low data register	0x00
0x17	RDATAH	R	Red ADC high data register	0x00
0x18	GDATA	R	Green ADC low data register	0x00

Page 24ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



Address	Register Name	R/W	Register Function	Reset Value
0x19	GDATAH	R	Green ADC high data register	0x00
0x1A	BDATA	R	Blue ADC low data register	0x00
0x1B	BDATAH	R	Blue ADC high data register	0x00
0x1C	PDATA	R	Proximity ADC low data register	0x00
0x1D	PDATAH	R	Proximity ADC high data register	0x00

The mechanics of accessing a specific register depends on the specific protocol used (See I2C Protocol). In general, the Command register is written first to specify the specific control/status register for following read/write operations.

ams Datasheet Page 25
[v1-31] 2018-Apr-04 Document Feedback



# **Command Register**

The Command Registers specifies the address of the target register for future write and read operations.

Figure 29: Command Register

7 6 5 4 3 2 1 0

COMMAND TYPE ADD

Field	Bits		Description			
COMMAND	7	Select Command Register. Must write as 1 when addressing Command Register.				
		Selects type of transaction to follow in subsequent data transfers:				
		Field Value	Integration Time			
		00	Repeated byte protocol transaction			
TYPE	6:5	01	Auto-increment protocol transaction			
		10	Reserved - Do not use			
		11	Special function - See description below			
		Byte protocol will repeatedly read the same register with each data access. Block protocol will provide auto-increment function to read successive bytes.				
		this field either spe control-status-regi	ial function field. Depending on the transaction type, see above, ecifies a special function command or selects the specific ster for following write and read transactions. The field values only to special function commands:			
		Field Value	Read Value			
		00000	Normal - no action			
ADD	4:0	00101	Proximity interrupt clear			
		00110	RGBC interrupt clear			
		00111	Proximity and RGBC interrupt clear			
		other	Reserved — Do not write			
		RGBC/Proximity In special function is	terrupt Clear. Clears any pending RGBC/Proximity interrupt. This self clearing.			

Page 26ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



# **Enable Register (0x00)**

The Enable Register is used primarily to power the TCS3771 device on and off, and enable functions and interrupts as shown in Figure 30.

Figure 30: **Enable Register** 

7 6 5 0 3 2 1 Reserved **PIEN AIEN WEN PEN AEN PON** 

Field	Bits	Description
Reserved	7:6	Reserved. Write as 0.
PIEN	5	Proximity interrupt enable. When asserted, permits proximity interrupts to be generated.
AIEN	4	RGBC interrupt enable. When asserted, permits RGBC interrupts to be generated.
WEN	3	Wait enable. This bit activates the wait feature. Writing a 1 activates the wait timer. Writing a 0 disables the wait timer.
PEN	2	Proximity enable. This bit activates the proximity function. Writing a 1 enables proximity. Writing a 0 disables proximity.
AEN	1	RGBC enable. This bit actives the two-channel ADC. Writing a 1 activates the RGBC. Writing a 0 disables the RGBC.
PON (1)	0	Power ON. This bit activates the internal oscillator to permit the timers and ADC channels to operate. Writing a 1 activates the oscillator. Writing a 0 disables the oscillator. During reads and writes over the I <sup>2</sup> C interface, this bit is temporarily overridden and the oscillator is enabled, independent of the state of PON.

#### Note(s):

1. A minimum interval of 2.4ms must pass after PON is asserted before either a proximity or an RGBC can be initiated. This required time is enforced by the hardware in cases where the firmware does not provide it.

ams Datasheet Page 27 **Document Feedback** 



## RGBC Timing Register (0x01)

The RGBC Timing Register controls the internal integration time of the RGBC clear and IR channel ADCs in 2.4ms increments.

Figure 31: RGBC Timing Register

Field	Bits	Description				
		Value	INTEG_CYCLES	Time	Max Count	
		0xFF	1	2.4ms	1024	
ATIME	7:0	0xF6	10	24ms	10240	
AllWL	ATTIVIE 7.0	0xD6	42	101ms	43008	
		0xAD	64	154ms	65535	
		0x00	256	614ms	65535	

# Proximity Time Control Register (0x02)

The Proximity Timing Register controls the integration time of the proximity ADC in 2.4ms increments. It is recommended that this register be programmed to a value of 0xFF (1 cycle, 1023 bits).

Max Prox Count =  $((256 - PTIME) \times 1024)) - 1$  up to a maximum of 65535

Figure 32: Proximity Time Control Register

Field	Bits	Description				
PTIME	7:0	Value	INTEG_CYCLES	Time	Max Count	
1 THVIL	7.0	0xFF	1	2.4ms	1023	

Page 28ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



## Wait Time Register (0x03)

Wait time is set 2.4ms increments unless the WLONG bit is asserted in which case the wait times are  $12 \times longer$ . WTIME is programmed as a 2's complement number.

Figure 33: Wait Time Register

Field	Bits	Description				
		Register Value	Wait Time	Time (WLONG = 0)	Time (WLONG = 1)	
WTIME	WTIME 7:0	0xFF	1	2.4ms	0.029 sec	
		0xAB	85	204ms	2.45 sec	
		0x00	256	614ms	7.4 sec	

# RGBC Interrupt Threshold Registers (0x04 – 0x07)

The RGBC Interrupt Threshold Registers provides the values to be used as the high and low trigger points for the comparison function for interrupt generation. If the value generated by the clear channel crosses below the lower threshold specified, or above the higher threshold, an interrupt is asserted on the interrupt pin.

Figure 34: RGBC Interrupt Threshold Registers

Register	Address	Bits	Description
AILTL	0x04	7:0	RGBC clear channel low threshold lower byte
AILTH	0x05	7:0	RGBC clear channel low threshold upper byte
AIHTL	0x06	7:0	RGBC clear channel high threshold lower byte
AIHTH	0x07	7:0	RGBC clear channel high threshold upper byte

ams Datasheet Page 29
[v1-31] 2018-Apr-04 Document Feedback



# Proximity Interrupt Threshold Registers (0x08 - 0x0B)

The Proximity Interrupt Threshold Registers provide the values to be used as the high and low trigger points for the comparison function for interrupt generation. If the value generated by proximity channel crosses below the lower threshold specified, or above the higher threshold, an interrupt is signaled to the host processor.

Figure 35: Proximity Interrupt Threshold Register

Register	Address	Bits	Description
PILTL	0x08	7:0	Proximity ADC channel low threshold lower byte
PILTH	0x09	7:0	Proximity ADC channel low threshold upper byte
PIHTL	0x0A	7:0	Proximity ADC channel high threshold lower byte
PIHTH	0x0B	7:0	Proximity ADC channel high threshold upper byte

Page 30ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



## Persistence Register (0x0C)

The Persistence Register controls the filtering interrupt capabilities of the device. Configurable filtering is provided to allow interrupts to be generated after each integration cycle or if the integration has produced a result that is outside of the values specified by the threshold register for some specified amount of time. Separate filtering is provided for proximity and the RGBC clear channel.

Figure 36: Persistence Register

7	6	5	4	3	2	1	0
	PPERS				АР	ERS	

Field	Bits	Description				
		Proximity interrupt persistence. Controls rate of proximity interrupt to the host processor.				
		Field Value	Meaning	Interrupt Persistence Function		
	PPERS 7:4	7:4	0000		Every proximity cycle generates an interrupt	
PPERS			7:4	0001	1	1 proximity value out of range
		0010	2	2 consecutive proximity values out of range		
		1111	15	15 consecutive proximity values out of range		

ams Datasheet Page 31
[v1-31] 2018-Apr-04 Document Feedback



Field	Bits	Description				
		Interrupt persi	stence. Controls	rate of interrupt to the host processor.		
		Field Value	Meaning	Interrupt Persistence Function		
		0000	Every	Every RGBC cycle generates an interrupt		
		0001	1	1 clear channel value outside of threshold range		
		0010	2	2 clear channel consecutive values out of range		
		0011	3	3 clear channel consecutive values out of range		
		0100	5	5 clear channel consecutive values out of range		
		0101	10	10 clear channel consecutive values out of range		
APERS	3:0	0110	15	15 clear channel consecutive values out of range		
APERS	3:0	0111	20	20 clear channel consecutive values out of range		
		1000	25	25 clear channel consecutive values out of range		
		1001	30	30 clear channel consecutive values out of range		
		1010	35	35 clear channel consecutive values out of range		
		1011	40	40 clear channel consecutive values out of range		
		1100	45	45 clear channel consecutive values out of range		
		1101	50	50 clear channel consecutive values out of range		
		1110	55	55 clear channel consecutive values out of range		
		1111	60	60 clear channel consecutive values out of range		

Page 32ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



## Configuration Register (0x0D)

The Configuration Register sets the wait long time.

Figure 37: **Configuration Register** 

7	6	5	4	3	2	1	0
	Reserved					WLONG	Reserved

Field	Bits	Description
Reserved	7:2	Reserved. Write as 0.
WLONG	1	Wait Long. When asserted, the wait cycles are increased by a factor 12× from that programmed in the WTIME register.
Reserved	0	Reserved. Write as 0.

## Proximity Pulse Count Register (0x0E)

The Proximity Pulse Count Register sets the number of proximity pulses that will be transmitted. When proximity detection is enabled, a proximity detect cycle occurs after each RGBC cycle. PPULSE defines the number of pulses to be transmitted.

**Note(s):** The ATIME register will be used to time the interval between proximity detection events even if the RGBC function is disabled.

Figure 38: **Proximity Pulse Count Register** 

7 5 6 4 3 2 1 0

**PPULSE** 

Field	Bits	Description
PPULSE	7:0	Proximity Pulse Count. Specifies the number of proximity pulses to be generated.

ams Datasheet Page 33 [v1-31] 2018-Apr-04 **Document Feedback** 



# Control Register (0x0F)

The Control Register provides eight bits of miscellaneous control to the analog block. These bits typically control functions such as gain settings and/or diode selection.

Figure 39: Control Register

7 6 5 4 3 2 1 0

PDRIVE PDIODE Reserved AGAIN

Field	Bits	Description		
PDRIVE		LED Drive Strength.		
		Field Value	LED Strength	
	7:6	00	100mA	
		01	50mA	
		10	25mA	
		11	12.5mA	
		Proximity Diode Select.		
	5:4	Field Value	Diode Selection	
PDIODE		00	Reserved	
IDIODL		01	Proximity uses the clear (broadband) diode	
		10	Proximity uses the IR diode	
		11	Proximity uses both the clear diode and the red diode	
Reserved	3:2	Reserved. Write bits as 0.		
AGAIN	1:0	RGBC Gain Control.		
		Field Value	RGBC Gain Value	
		00	1× gain	
		01	4× gain	
		10	16× gain	
		11	60× gain	

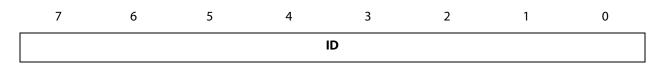
Page 34ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



# ID Register (0x12)

The ID Register provides the value for the part number. The ID Register is a read-only register.

Figure 40: ID Register



Field	Bits	Description	
ID	7:0	Part number identification	0x10 = TCS37715
			0x19 = TCS37717

## Status Register (0x13)

The Status Register provides the internal status of the device. This register is read only.

Figure 41: Status Register

 7
 6
 5
 4
 3
 2
 1
 0

 Reserved
 PINT
 AINT
 Reserved
 PVALID
 AVALID

Field	Bits	Description
Reserved	7:6	Reserved
PINT	5	Proximity Interrupt
AINT	4	RGBC clear channel Interrupt
Reserved	3:2	Reserved
PVALID	1	Proximity Valid. Indicates that a RGBC cycle has completed since AEN was asserted.
AVALID	0	RGBC Valid. Indicates that the RGBC channels have completed an integration cycle.

ams Datasheet Page 35
[v1-31] 2018-Apr-04 Document Feedback



#### RGBC Channel Data Registers (0x14 - 0x1B)

Clear, red, green, and blue data is stored as 16-bit values. To ensure the data is read correctly, a two-byte read I<sup>2</sup>C transaction should be used with a read word protocol bit set in the Command Register. With this operation, when the lower byte register is read, the upper eight bits are stored into a shadow register, which is read by a subsequent read to the upper byte. The upper register will read the correct value even if additional ADC integration cycles end between the reading of the lower and upper registers.

Figure 42:
ADC Channel Data Registers

Register	Address	Bits	Description
CDATA	0x14	7:0	Clear data low byte
CDATAH	0x15	7:0	Clear data high byte
RDATA	0x16	7:0	Red data low byte
RDATAH	0x17	7:0	Red data high byte
GDATA	0x18	7:0	Green data low byte
GDATAH	0x19	7:0	Green data high byte
BDATA	0x1A	7:0	Blue data low byte
BDATAH	0x1B	7:0	Blue data high byte

## Proximity Data Registers (0x1C - 0x1D)

Proximity data is stored as a 16-bit value. To ensure the data is read correctly, a two-byte read I<sup>2</sup>C transaction should be used with a read word protocol bit set in the Command Register. With this operation, when the lower byte register is read, the upper eight bits are stored into a shadow register, which is read by a subsequent read to the upper byte. The upper register will read the correct value even if additional ADC integration cycles end between the reading of the lower and upper registers.

Figure 43: PDATA Registers

Register	Address	Bits	Description
PDATA	0x1C	7:0	Proximity data low byte
PDATAH	0x1D	7:0	Proximity data high byte

Page 36
Document Feedback
[v1-31] 2018-Apr-04



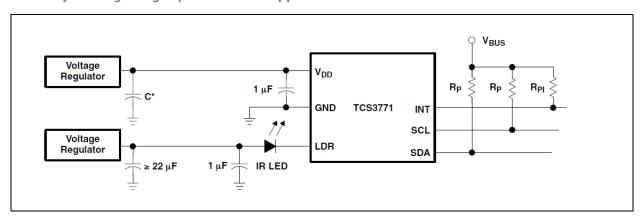
#### **Application Information**

#### **LED Driver Pin with Proximity Detection**

In a proximity sensing system, the IR LED can be pulsed by the TCS3771 with more than 100mA of rapidly switching current, therefore, a few design considerations must be kept in mind to get the best performance. The key goal is to reduce the power supply noise coupled back into the device during the LED pulses.

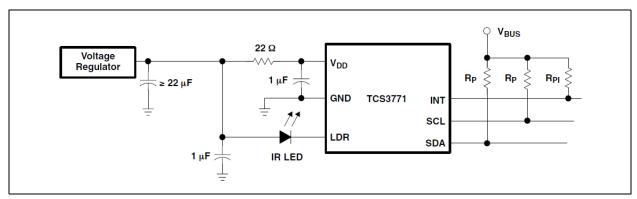
The first recommendation is to use two power supplies; one for the device  $V_{DD}$  and the other for the IR LED. In many systems, there is a quiet analog supply and a noisy digital supply. By connecting the quiet supply to the  $V_{DD}$  pin and the noisy supply to the LED, the key goal can be meet. Place a  $1\mu F$  low-ESR decoupling capacitor as close as possible to the  $V_{DD}$  pin and another at the LED anode, and a  $22\mu F$  capacitor at the output of the LED voltage regulator to supply the 100mA current surge.

Figure 44:
Proximity Sensing Using Separate Power Supplies



If it is not possible to provide two separate power supplies, the device can be operated from a single supply. A  $22\Omega$  resistor in series with the  $V_{DD}$  supply line and a  $1\mu F$  low ESR capacitor effectively filter any power supply noise. The previous capacitor placement considerations apply.

Figure 45:
Proximity Sensing Using Single Power Supply



ams Datasheet Page 37
[v1-31] 2018-Apr-04 Document Feedback



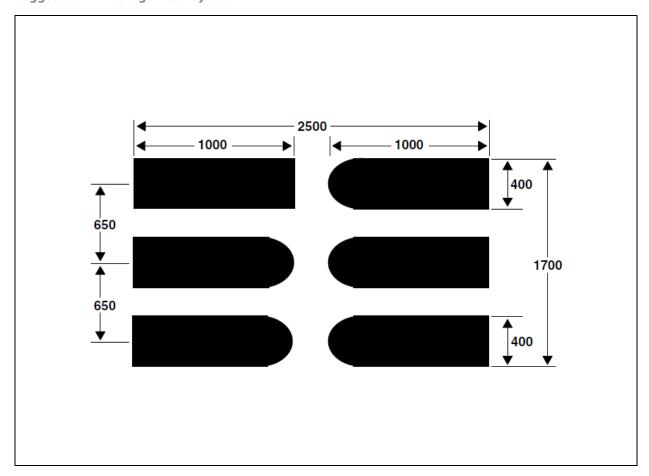
 $V_{BUS}$  in the above figures refers to the  $I^2C$  bus voltage which is either  $V_{DD}$  or 1.8V. Be sure to apply the specified  $I^2C$  bus voltage shown in the Available Options table for the specific device being used.

The I<sup>2</sup>C signals and the Interrupt are open-drain outputs and require pull–up resistors. The pull-up resistor (RP) value is a function of the I<sup>2</sup>C bus speed, the I<sup>2</sup>C bus voltage, and the capacitive load. The ams EVM running at 400kbps, uses  $1.5k\Omega$  resistors. A  $10k\Omega$  pull-up resistor (RPI) can be used for the interrupt line.

#### **PCB Pad Layout**

Suggested PCB pad layout guidelines for the Dual Flat No-Lead (FN) surface mount package are shown in Figure 46.

Figure 46: Suggested FN Package PCB Layout



#### Note(s):

- 1. All linear dimensions are in millimeters.
- 2. This drawing is subject to change without notice.
- 3. Pads can be extended further if hand soldering is needed.

Page 38

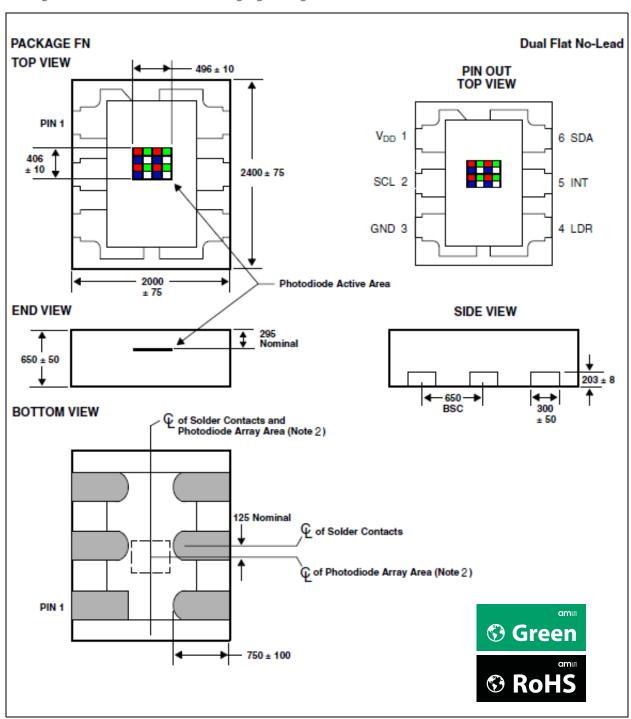
Document Feedback

[v1-31] 2018-Apr-04



## **Packaging Mechanical Data**

Figure 47:
Package FN - Dual Flat No-Lead Packaging Configuration



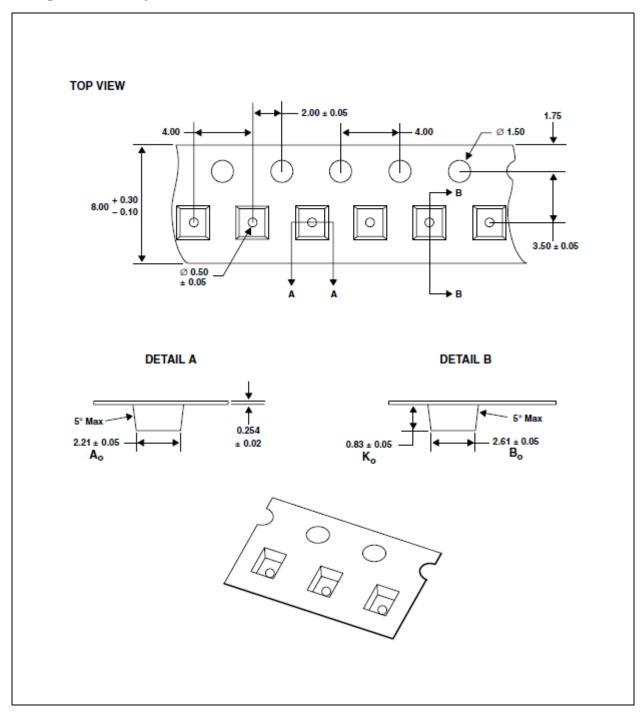
#### Note(s):

- 1. All linear dimensions are in micrometers.
- 2. The die is centered within the package within a tolerance of  $\pm 75 \mu m.$
- 3. Package top surface is molded with an electrically nonconductive clear plastic compound having an index of refraction of 1.55.
- 4. Contact finish is copper alloy A194 with pre-plated NiPdAu lead finish.
- 5. This package contains no lead (Pb).
- 6. This drawing is subject to change without notice.

ams Datasheet Page 39
[v1-31] 2018-Apr-04 Document Feedback



Figure 48: Package FN Carrier Tape



#### Note(s):

- 1. All linear dimensions are in millimeters. Dimension tolerance is  $\pm 0.10$ mm unless otherwise noted.
- 2. The dimensions on this drawing are for illustrative purposes only. Dimensions of an actual carrier may vary slightly.
- 3. Symbols on drawing  $\rm A_{o}, \rm B_{o},$  and  $\rm K_{o}$  are defined in ANSI EIA Standard 481-B 2001.
- 4. Each reel is 178 millimeters in diameter and contains 3500 parts.
- 5. ams AG packaging tape and reel conform to the requirements of EIA Standard 481-B.
- 6. In accordance with EIA standard, device pin 1 is located next to the sprocket holes in the tape.
- 7. This drawing is subject to change without notice.

Page 40ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



## **Manufacturing Information**

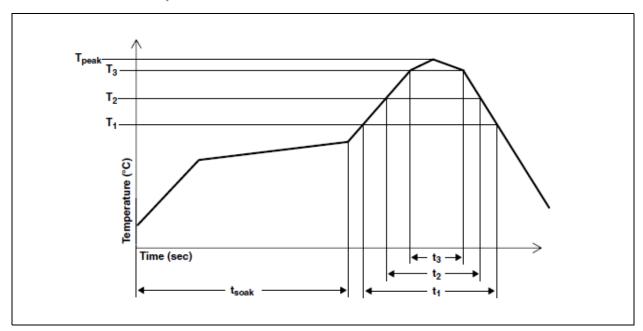
The FN package has been tested and has demonstrated an ability to be reflow soldered to a PCB substrate.

The solder reflow profile describes the expected maximum heat exposure of components during the solder reflow process of product on a PCB. Temperature is measured on top of component. The components should be limited to a maximum of three passes through this solder reflow profile.

Figure 49: TCS3771 Solder Reflow Profile

Parameter	Reference	TCS3771
Average temperature gradient in preheating		2.5°C/sec
Soak time	t <sub>soak</sub>	2 to 3 minutes
Time above 217°C (T1)	t <sub>1</sub>	Max 60 sec
Time above 230°C (T2)	t <sub>2</sub>	Max 50 sec
Time above T <sub>peak</sub> - 10°C (T3)	t <sub>3</sub>	Max 10 sec
Peak temperature in reflow	T <sub>peak</sub>	260° C
Temperature gradient in cooling		Max -5°C/sec

Figure 50: Solder Reflow Profile Graph



#### Note(s):

1. Not to scale - for reference only.

ams Datasheet Page 41
[v1-31] 2018-Apr-04 Document Feedback



#### **Moisture Sensitivity**

Optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package. To ensure the package contains the smallest amount of absorbed moisture possible, each device is dry-baked prior to being packed for shipping. Devices are packed in a sealed aluminized envelope called a moisture barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

The FN package has been assigned a moisture sensitivity level of MSL 3 and the devices should be stored under the following conditions:

• Temperature Range: 5°C to 50°C

• Relative Humidity: 60% maximum

• Total Time: 12 months from the date code on the aluminized envelope - if unopened

• Opened Time: 168 hours or fewer

Rebaking will be required if the devices have been stored unopened for more than 12 months or if the aluminized envelope has been open for more than 168 hours. If rebaking is required, it should be done at 50°C for 12 hours.

Page 42

Document Feedback

[v1-31] 2018-Apr-04



## **Ordering & Contact Information**

Figure 51: **Ordering Information** 

Ordering Code	Device	Address	Package - Leads	Interface Description
TCS37715FN	TCS37715	0x29	FN-6	$I^2C$ Vbus = $V_{DD}$ Interface
TCS37717FN	TCS37717	0x29	FN-6	I <sup>2</sup> C Vbus = 1.8V Interface

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ams Datasheet Page 43 **Document Feedback** 



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Page 44

Document Feedback

[v1-31] 2018-Apr-04



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ams Datasheet Page 45 Document Feedback



### **Document Status**

Document Status	Product Status	Definition
Product Preview	Pre-Development	Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice
Preliminary Datasheet	Pre-Production	Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice
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Page 46ams DatasheetDocument Feedback[v1-31] 2018-Apr-04



#### **Revision Information**

Changes from 1-30 (2014-Sep-01) to current revision 1-31 (2018-Apr-04)	Page
Updated Figure 7	7
Updated Figure 40	35
Updated Figure 51	43

#### Note(s):

- 1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- $2. \ Correction \ of \ typographical \ errors \ is \ not \ explicitly \ mentioned.$

ams Datasheet Page 47 Document Feedback



#### **Content Guide**

#### 1 General Description

- 2 Key Benefits & Features
- 2 Applications
- 3 End Products and Market Segments
- 3 Block Diagram
- 4 Detailed Description
- 5 Pin Assignments
- 6 Absolute Maximum Ratings
- 7 Electrical Characteristics
- 12 Parameter Measurement Information
- 13 Typical Characteristics

#### 16 Principles of Operation

- 16 System State Machine
- 17 RGBC Operation
- 18 Proximity Detection
- 20 Interrupts
- 22 State Diagram
- 23 I2C Protocol
- 24 Register Set
- 26 Command Register
- 27 Enable Register (0x00)
- 28 RGBC Timing Register (0x01)
- 28 Proximity Time Control Register (0x02)
- 29 Wait Time Register (0x03)
- 29 RGBC Interrupt Threshold Registers (0x04 0x07)
- 30 Proximity Interrupt Threshold Registers (0x08 0x0B)
- 31 Persistence Register (0x0C)
- 33 Configuration Register (0x0D)
- 33 Proximity Pulse Count Register (0x0E)
- 34 Control Register (0x0F)
- 35 ID Register (0x12)
- 35 Status Register (0x13)
- 36 RGBC Channel Data Registers (0x14 0x1B)
- 36 Proximity Data Registers (0x1C 0x1D)

#### 37 Application Information

- 37 LED Driver Pin with Proximity Detection
- 38 PCB Pad Layout

#### 39 Packaging Mechanical Data

#### 41 Manufacturing Information

- 42 Moisture Sensitivity
- 43 Ordering & Contact Information
- 44 RoHS Compliant & ams Green Statement
- 45 Copyrights & Disclaimer
- **46 Document Status**
- 47 Revision Information

Page 48
Document Feedback
[v1-31] 2018-Apr-04

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